

1. Description

The PC814A is a photoelectric coupler composed of two light-emitting diode and phototransistor. It is packaged in a 4-pin package, two forms (DIP, SMD)

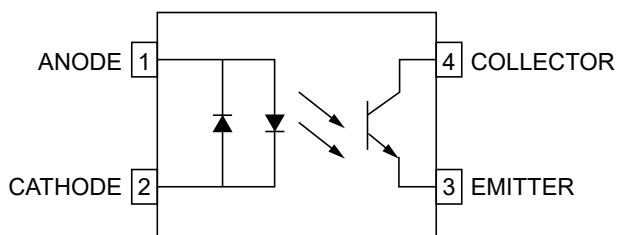
2. Features

- Current transfer ratio:
20~300% ($I_F=5mA$, $V_{CE}=5V$)
- High isolation voltage between input and output
($V_{ISO}=5000V_{rms}$)
- Collector-emitter breakdown voltage $BV_{CEO} \geq 80V$
- Meet safety standard approval: EU REACH and RoHS

3. Applications

- Switching power supply, intelligent meter
- Industrial control, measuring instruments
- Office equipment such as copiers
- Household appliances: such as air conditioners, fans, water heaters, etc.

4. Pinning Information



DIP-4



SOP-4



5. Absolute Maximum Ratings ($T_A=25^\circ\text{C}$)

| Parameter | | Symbol | Rating | Unit |
|-------------------------|--|-------------|------------|---------------------------|
| Input | Forward Current | I_F | ± 50 | mA |
| | Power Dissipation | P | 70 | mW |
| | PowerdissipationDerating factor (above $T_A=100^\circ\text{C}$) | P_{DD} | 2.9 | mW/ $^\circ\text{C}$ |
| | Thermal Resistance Junction-Ambient | R_{thJ-A} | 325 | $^\circ\text{C}/\text{W}$ |
| | Thermal Resistance Junction-Case | R_{thJ-C} | 200 | $^\circ\text{C}/\text{W}$ |
| Output | Collector Power Dissipation | P_C | 150 | mW |
| | Collector Current | I_C | 50 | mA |
| | Collector-Emitter Voltage | V_{CEO} | 80 | V |
| | Emitter - Collector Voltage | V_{ECO} | 6 | V |
| Total Power Dissipation | | P_{TOT} | 200 | mW |
| Isolation Voltage | | V_{ISO} | 5000 | Vrms |
| Operating Temperature | | T_{OPR} | -55 to 110 | $^\circ\text{C}$ |
| Storage Temperature | | T_{STG} | -55 to 125 | $^\circ\text{C}$ |
| Soldering Temperature | | T_{SOL} | 260 (10s) | $^\circ\text{C}$ |



6. Electrical Characteristics ($T_A=25^\circ\text{C}$)

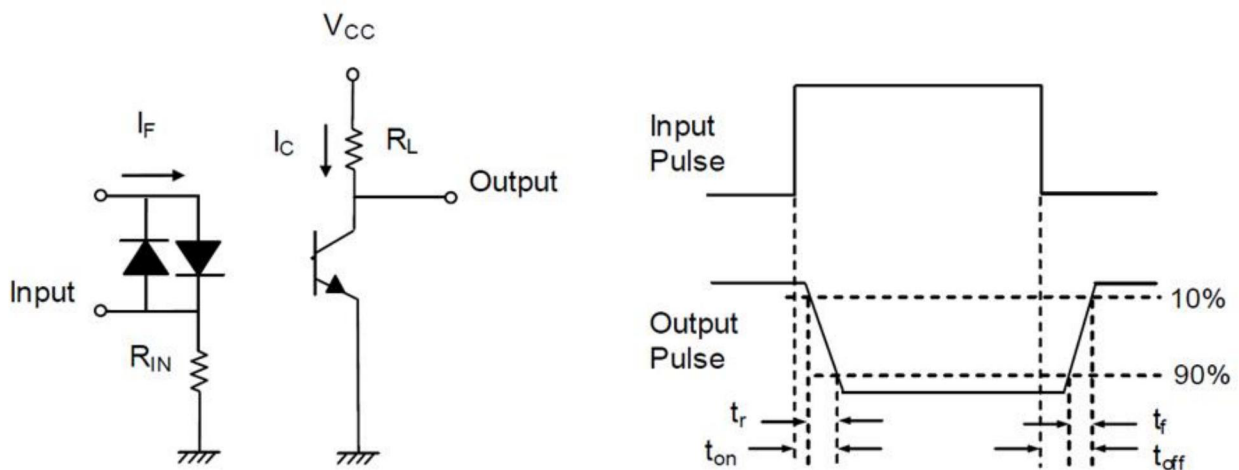
| Parameter | Symbol | Conditions | Min | Typ | Max | Units |
|--------------------------------------|---------------|--|--------------------|--------------------|-----|---------------|
| Input | | | | | | |
| Forward Voltage | V_F | $I_F=\pm 20\text{mA}$ | | 1.2 | 1.4 | V |
| Terminal Capacitance | C_t | $V=0, f=1\text{kHz}$ | | 30 | 250 | pF |
| Output | | | | | | |
| Collector Dark Current | I_{CEO} | $V_{CE}=20\text{V}$ | | | 100 | nA |
| Collector-Emitter Breakdown Voltage | BV_{CEO} | $I_C=0.1\text{mA}, I_F=0$ | 80 | | | V |
| Emitter-Collector Breakdown Voltage | BV_{ECO} | $I_E=0.1\text{mA}, I_F=0$ | 6 | | | V |
| Transfer Characteristics | | | | | | |
| Current Transfer Ratio | CTR | $I_F=5\text{mA}, V_{CE}=5\text{V}$ | 20 | | 300 | % |
| Collector-Emitter Saturation Voltage | $V_{CE(sat)}$ | $I_F=20\text{mA}, I_C=1\text{mA}$ | | 0.1 | 0.2 | V |
| Isolation Resistance | R_{ISO} | DC500V, 40~60%R.H. | 5×10^{10} | 1×10^{11} | | Ω |
| Isolation Capacitance | C_f | $V=0, f=1\text{MHz}$ | | 0.6 | 1 | pF |
| Cut-off Frequency | F_C | $V_{CE}=5\text{V}, I_C=2\text{mA}, R_L=100\Omega, -3\text{dB}$ | | 80 | | kHz |
| Switching Characteristics | | | | | | |
| Rise Time | T_r | $V_{CE}=2\text{V}, I_C=2\text{mA}$ | | 4 | 18 | μs |
| Fall Time | T_f | $R_L=100\Omega$ | | 3 | 18 | μs |



7.Rank Table of CTR

| Type | Classification | Current Transfer Ratio (%) (I_C/I_F) | | |
|-------|----------------|--|-----|-----|
| | | $I_F = \pm 5\text{mA}, V_{CE} = 5\text{V}, T_A = 25^\circ\text{C}$ | | |
| | | Min | Typ | Max |
| PC814 | A | 50 | - | 150 |
| | B | 100 | - | 300 |
| | None | 20 | - | 300 |

8.Switching Time Test Circuit



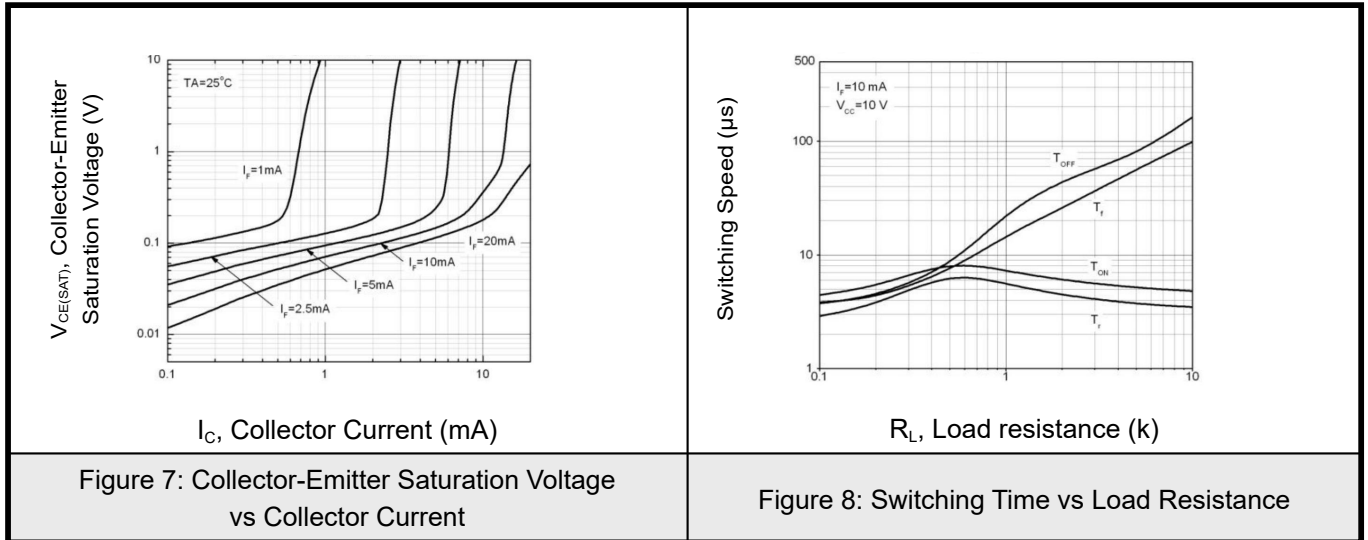


9.1 Typical Characteristic

| | |
|--|---|
| | |
| <p>Figure 1: Forward Current vs Forward Voltage</p> | <p>Figure 2: Normalized Current Transfer Ratio vs Forward Current</p> |
| | |
| <p>Figure 3: Current Transfer Ratio vs Ambient Temperature</p> | <p>Figure 4: Dark Current vs Ambient Temperature</p> |
| | |
| <p>Figure 5: Collector Current vs Collector Voltage</p> | <p>Figure 6: Collector Current vs Collector Voltage</p> |



9.2 Typical Characteristic





10.Solder Reflow Profile

Soldering Precautions

Whether using a soldering iron or reflow soldering, the soldering temperature should be as close as possible to the conditions shown below.

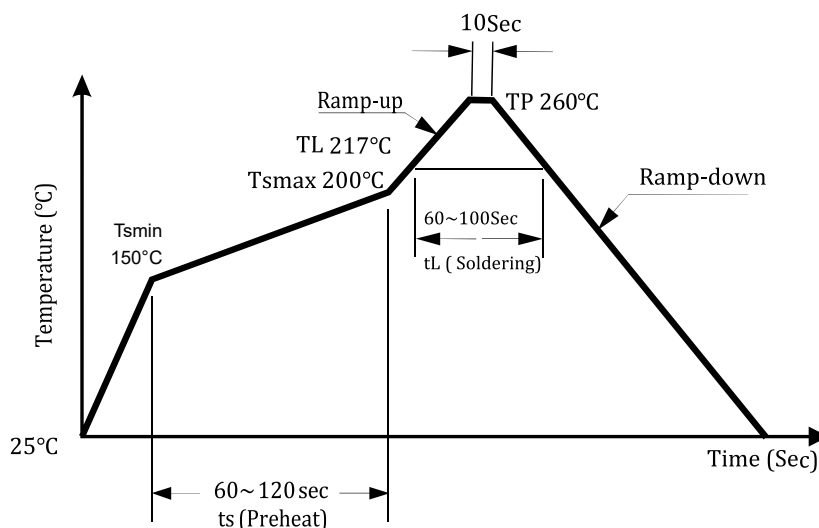
- When reflow soldering Reflow

soldering should be completed within 10 seconds if reflow

soldering does not exceed 260°C. The soldering temperature profile is based on the surface temperature of the plastisol (see the chart below, based on the surface temperature of the plastisol).

Reflow soldering is limited to one or two passes.

It must be used within 2 weeks after unpacking

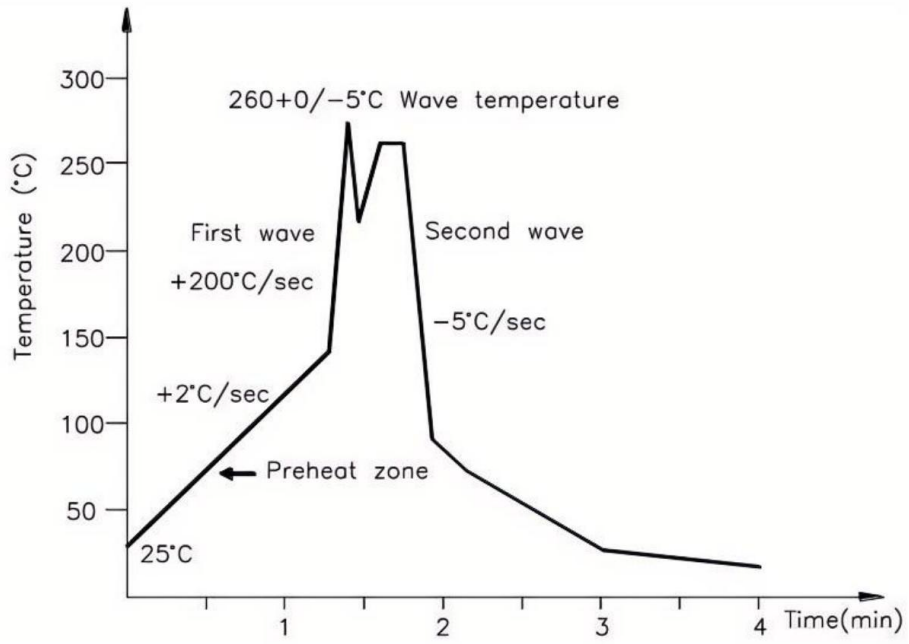


- Wave soldering

It is recommended to perform one-time soldering under temperature conditions.

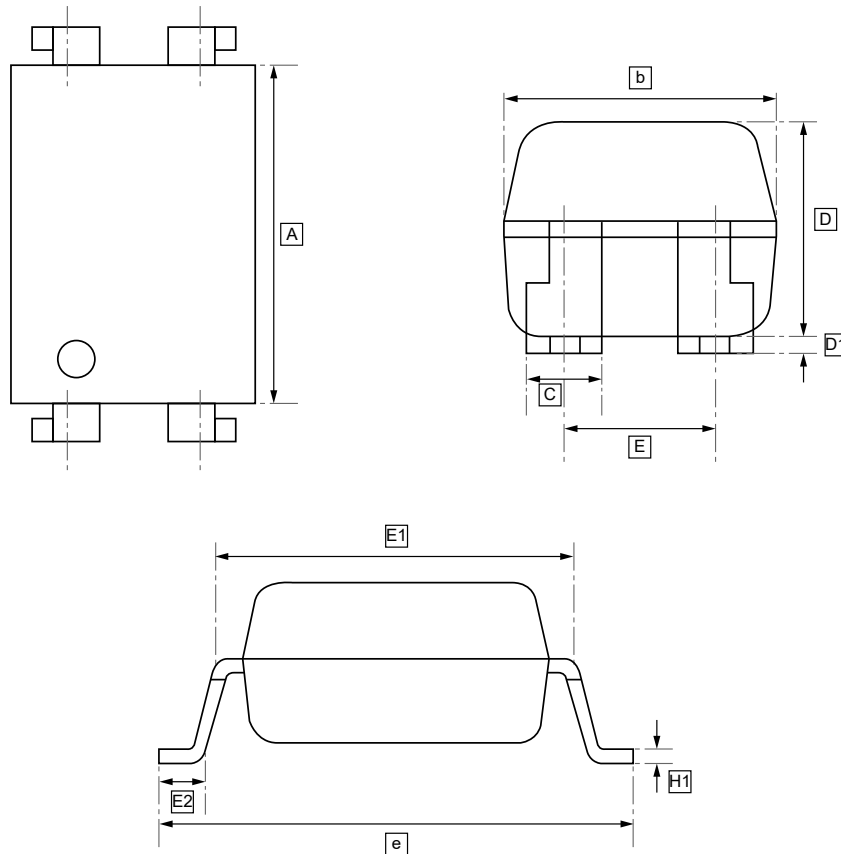
Temperature: 260+0/-5°C Time: 10 sec.

Preheat temperature: 25 to 140°C Preheat time: 30 to 80 seconds.





11.1 SOP-4 Package Outline Dimensions

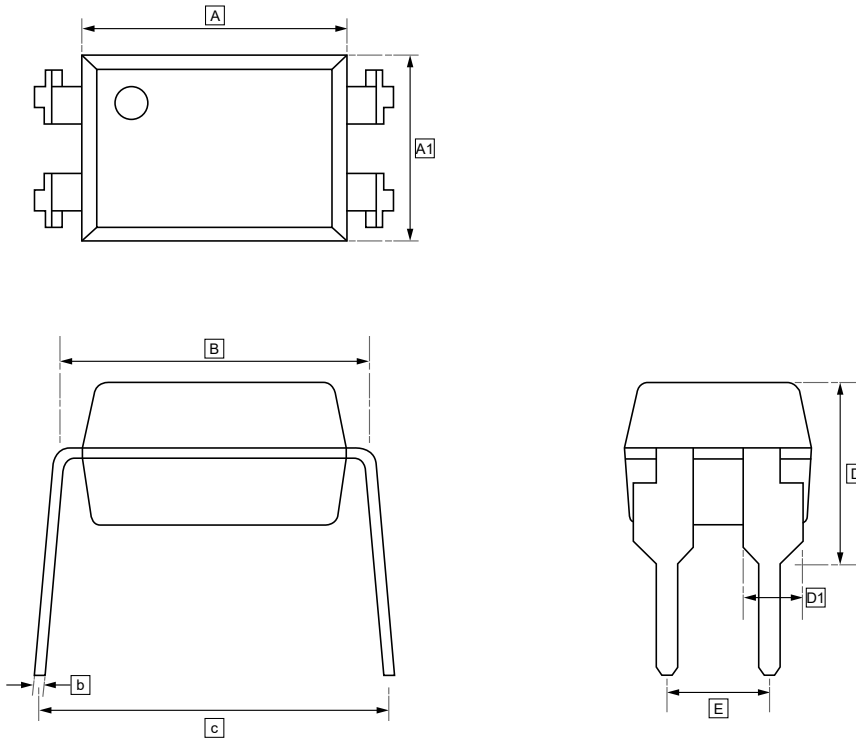


DIMENSIONS (mm are the original dimensions)

| Symbol | A | b | C | D | D1 | E | E1 | E2 | e | H1 |
|------------|------|------|------|-----|------|------|------|------|------|------|
| Min | 6.15 | 4.33 | 1.25 | 3.4 | 0.05 | 2.29 | 7.37 | 0.75 | 10.0 | 0.26 |
| Max | 6.65 | 4.83 | 1.45 | 3.9 | 0.6 | 2.79 | 7.87 | 1.25 | 10.6 | |



11.2 DIP-4 Package Outline Dimensions

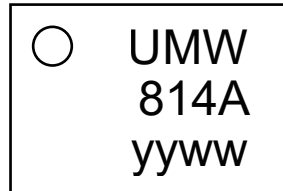


DIMENSIONS (mm are the original dimensions)

| Symbol | A | A1 | B | b | c | D | D1 | E |
|------------|------|------|------|------|------|------|------|------|
| Min | 6.15 | 4.33 | 7.37 | 0.26 | 7.85 | 3.40 | 1.25 | 2.54 |
| Max | 6.65 | 4.83 | 7.87 | | 8.80 | 3.90 | 1.45 | TYP |



12. Ordering Information



yy: Year Code
ww: Week Code

| Order Code | Marking | Package | Base QTY | Delivery Mode |
|--------------|---------|---------|----------|---------------|
| UMW PC814A-S | 814A | SOP-4 | 2000 | Tape and reel |
| UMW PC814A | 814A | DIP-4 | 5000 | Tube and box |



13.Disclaimer

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